

Solid Tantalum Chip Capacitors MICROTANTM High Reliability, Low DCL, Leadframeless Molded





PERFORMANCE CHARACTERISTICS

Operating Temperature: - 55 °C to + 85 °C

(to + 125 °C with voltage derating)

FEATURES

· High reliability solid surface mount tantalum capacitors



RoHS

COMPLIANT

· Low DCL for extended battery life

• Small sizes for space constrained applications

- · L-shaped terminations for superior board mounting
- Suitable for medical implantable applications additional screening
- Compliant to RoHS directive 2002/95/EC

Capacitance Range: 1 μF to 47 μF

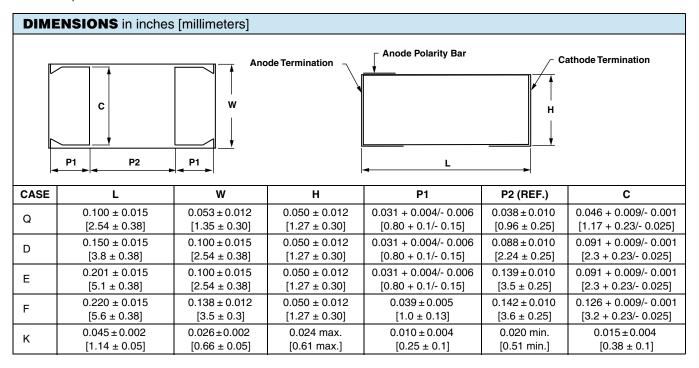
Capacitance Tolerance: ± 10 % and ± 20 % standard

Voltage Range: 2 WV_{DC} to 40 WV_{DC}

ORD	ORDERING INFORMATION							
TM8	R	106	М	016	E	В	Α	
MODEL	CASE CODE	CAPACITANCE	CAPACITANCE TOLERANCE	DC VOLTAGE RATING AT + 85 °C	TERMINATION/ PACKAGING	RELIABILITY LEVEL	SURGE CURRENT	
	See Ratings and Case Codes Table	This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow.	$K = \pm 10 \%$ $M = \pm 20 \%$	This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V).	E = Sn/Pb solder/ 7" (178 mm) reels R = Sn/Pb solder/ 7" (178 mm) 300 pcs. qty. C = 100 % tin/ 7" (178 mm) reels U = 100 % tin/ 7" (178 mm) 300 pcs. qty.	B = 0.1 % weibull FRL S = Hi-Rel std. (40 h burn-in) Z = Non- established reliability	A = 10 cycles at 25 °C B = 10 cycles at - 55 °C/+ 85 °C Z = None	

Note

· Standard options are in bold



Document Number: 40133 Revision: 22-Jun-10



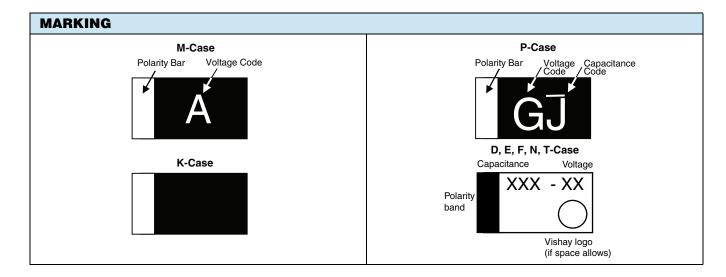
Vishay Sprague

DIME	DIMENSIONS in inches [millimeters]							
CASE	L	w	Н	P1	P2 (REF.)	С		
L	0.081 ± 0.008 [2.05 ± 0.2]	0.051±0.004 [1.3 ± 0.10]	0.04 max. [1.0 max.]	0.020 ± 0.004 [0.50 ± 0.1]	0.027 min. [0.70 min.]	0.035 + 0.009/- 001 [0.9+0.23/- 0.02]		
М	0.063 ± 0.006 [1.60 ± 0.15]	0.033 ± 0.006 [0.84 ± 0.15]	0.033 ± 0.006 [0.84 ± 0.15]	0.020 ± 0.004 [0.51 ± 0.1]	0.019 min. [0.48 min.]	0.024±0.004 [0.61 ± 0.1]		
N	0.138+0.004/-0.008 [3.505+0.101/-0.203]	0.110 ± 0.004 [2.80 \pm 0.1]	0.04 max. [1.0 max.]	0.031 + 0.004/- 0.006 [0.80 + 0.1/- 0.15]	0.088±0.010 [2.24 ± 0.25]	0.091 + 0.009/- 0.001 [2.3 + 0.23/- 0.025]		
Р	0.096 ± 0.006 [2.45 ± 0.15]	0.059 ± 0.006 [1.5 ± 0.15]	0.049 max. [1.25 max.]	0.020±0.004 [0.51 ± 0.1]	0.043 min. [1.1 min.]	0.035 ± 0.004 $[0.90 \pm 0.1]$		
R	0.081 ± 0.006 [2.06 ± 0.15]	0.053 ± 0.006 [1.35 ± 0.15]	0.058 ± 0.004 [1.47 ± 0.10]	0.020 ± 0.004 [0.51 \pm 0.1]	0.028 min. [0.71 min.]	0.035 ± 0.004 $[0.90 \pm 0.1]$		
Т	0.138+0.004/-0.008 [3.505 + 0.101/- 0.203]	0.110 ± 0.004 [2.80 ± 0.1]	0.06 max. [1.52 max.]	0.031 + 0.004/- 0.006 [0.80 + 0.1/- 0.15]	0.088±0.010 [2.24 ± 0.25]	0.091 + 0.009/- 0.001 [2.3 + 0.23/- 0.025]		
W	0.081 ± 0.006 [2.06 ± 0.15]	0.053±0.006 [1.35 ± 0.15]	0.047 max. [1.2 max.]	0.020 ± 0.004 [0.51 ± 0.1]	0.028 min. [0.71 min.]	0.035 ± 0.004 [0.90 ± 0.1]		

RATINGS AND CASE CODES						
F	6.3 V	10 V	16 V	20 V	25 V	40 V
1.0		M	М	W	R	Р
2.2						
3.3				R		
4.7		M			Р	
7.5		L		N*		
10	M	R	R			
15	M					
22						
33						
47		Т				

Note

^{*} Preliminary values, contact factory for availability.



TM8

Vishay Sprague

Solid Tantalum Chip Capacitors MICROTANTM High Reliability, Low DCL, Leadframeless Molded

STANDARD RA	TINGS				
CAPACITANCE CASE (μF) CODE		PART NUMBER	MAX. DC LEAKAGE AT + 25 °C (μA)	MAX. DF AT + 25 °C (%)	MAX. ESR AT + 25 °C 100 kHz STD. (Ω)
		6.3 WV _{DC} AT + 85 °C, 4 V			
10	М	TM8M106(1)6R3(2)(3)(5)	0.32	8	5.0
15	M	TM8M156(1)6R3(2)(3)(5)	0.47	8	5.0
		10 WV _{DC} AT + 85 °C, 7 W	/V _{DC} AT + 125 °C		
1.0	М	TM8M105(1)010(2)(3)(5)	0.20	6	12.0
4.7	M	TM8M475(1)010(2)(3)(5)	0.24	8	6.0
7.5	L	TM8L755(1)010(2)(3)(5)	0.38	8	8.0
10 R TM8R106(1)0		TM8R106(1)010(2)(3)(5)	0.50	8	6.0
47	Т	TM8T476(1)010(2)(3)(5)	2.35	8	1.0
		16 WV _{DC} AT + 85 °C, 10 \	NV _{DC} AT + 125 °C		
1.0	М	TM8M105(1)016(2)(3)(5)	0.20	6	12.0
10	R	TM8R106(1)016(2)(3)(5)	0.80	8	6.0
		20 WV _{DC} AT + 85 °C, 13 \	NV _{DC} AT + 125 °C		
1.0	W	TM8W105(1)020(2)(3)(5)	0.20	8	8.0
3.3	R	TM8R335(1)020(2)(3)(5)	0.33	8	8.0
7.5	N	TM8N755(1)020(2)(3)(5)*	0.93	8	8.0
		25 WV _{DC} AT + 85 °C, 17 \	NV _{DC} AT + 125 °C		
1.0	R	TM8R105(1)025(2)(3)(5)	0.20	6	10.0
4.7	Р	TM8P475(1)025(2)(3)(5)	0.59	6	6.0
		40 WV _{DC} AT + 85 °C, 27 V	NV _{DC} AT + 125 °C		
1.0	Р	TM8P105(1)040(2)(3)(5)	0.20	8	10.0

Notes

Revision: 22-Jun-10

Document Number: 40133

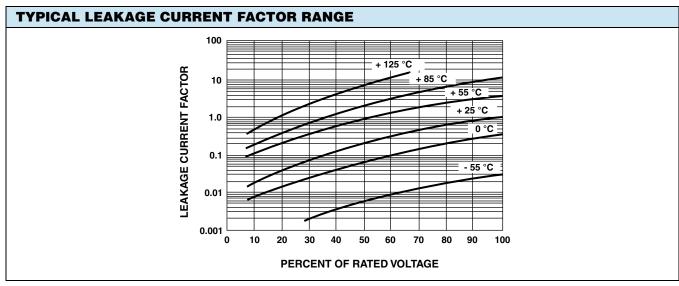
⁽¹⁾ Capacitance tolerance: K, M
(2) Termination and Packaging: E, C
(3) Reliability level: Z, S, B
(4) Reliability level: Z only
(5) Surge current: Z, A, B
(6) Surge current: Z only
* Preliminary ratings: contact factory for availability



Vishay Sprague

CAPACITORS PERFORMANCE CHARACTERISTICS

ELECTRICAL PERFO	RMANCE CHARACTERISTICS				
ITEM	PERFORMANCE CHARACTERISTICS				
Category Temperature Range	- 55 °C to + 85 °C (to + 125 °C with voltage derating)				
Capacitance Tolerance	± 20 %, ± 10 % (at 120 Hz) 1 V _{rms} at + 25 °C using a	a capacitance bridge			
Dissipation Factor (at 120 Hz)	Limits per Standard Ratings table. Tested via bridge	method, at 25 °C, 120 Hz.			
ESR (100 kHz)	Limits per Standard Ratings table. Tested via bridge	method, at 25 °C, 100 kHz.			
Leakage Current	After application of rated voltage applied to capacitors for 5 minutes using a steady source of power with 1 k Ω resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in Standard Ratings Table. Note that the leakage current varies with temperature and applied voltage. See graph below for the appropriate adjustment factor.				
Reverse Voltage	Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at + 25 °C or 5 % of the DC rating at + 85 °C. Vishay does not recommended intentional or repetitive application of reverse voltage.				
Temperature Derating	If capacitors are to be used at temperatures above + 25 °C, the permissible rms ripple current or voltage shall be calculated using the derating factors: 1.0 at + 25 °C 0.9 at + 85 °C 0.4 at + 125 °C				
	+ 85 °C RATING	+ 125 °C RATING			
	WORKING VOLTAGE (V)	WORKING VOLTAGE (V)			
	2	1.3			
	4	2.7			
	6.3	4			
Operating Temperature	10	7			
	15	10			
	16	10			
	20	13			
	25 17				
	40	27			

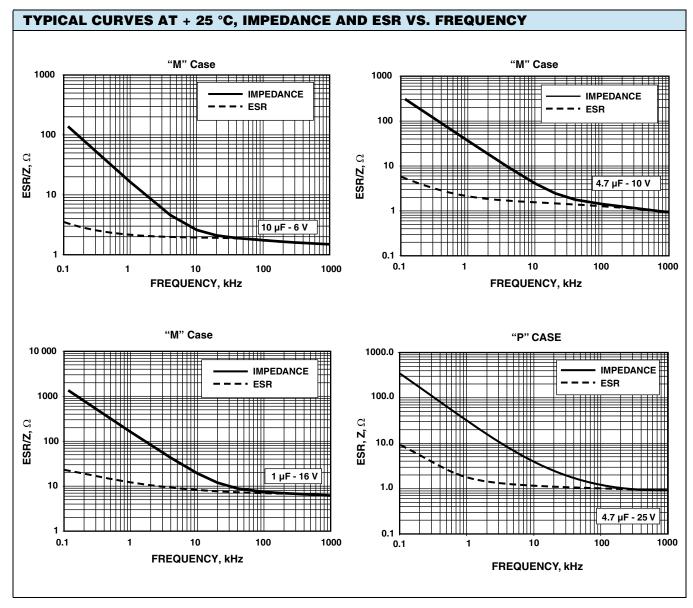


Notes

- At + 25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table
- At + 85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table
- At + 125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table

Solid Tantalum Chip Capacitors MICROTANTM High Reliability, Low DCL, Leadframeless Molded

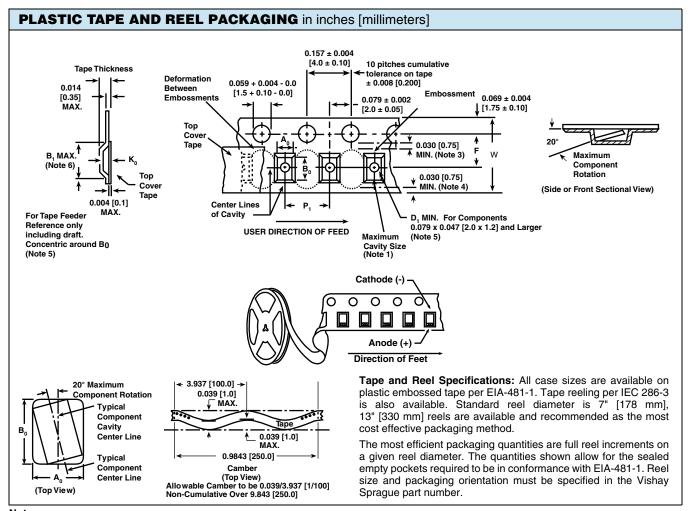




Document Number: 40133



Vishay Sprague



Note

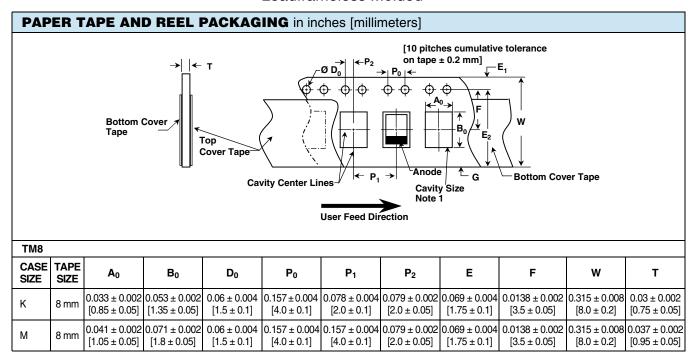
Metric dimensions will govern. Dimensions in inches are rounded and for reference only.

CASE CODE	TAPE SIZE	B ₁ (MAX.)	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	W
TM8							
Р	8 mm	0.108 (2.75)	0.039 (1.0)	0.138 (3.5)	0.054 (1.37)	0.157 (4.0)	0.315 (8.0)
Q	8 mm	0.135 (3.43)	0.039 (1.0)	0.138 (3.5)	0.065 (1.65)	0.157 (4.0)	0.315 (8.0)
L	8 mm	0.094 (2.4)	0.039 (1.0)	0.138 (3.5)	0.047 (1.2)	0.157 (4.0)	0.315 (8.0)
R	8 mm	0.112 (2.85)	0.039 (1.0)	0.138 (3.5)	0.066 (1.68)	0.157 (4.0)	0.315 (8.0)
W	8 mm	0.112 (2.85)	0.039 (1.0)	0.138 (3.5)	0.053 (1.35)	0.157 (4.0)	0.315 (8.0)
D	12 mm	0.154 (3.9)	0.059 (1.5)	0.216 (5.5)	0.051 (1.3)	0.157 (4.0)	0.472 (12.0)
E	12 mm	0.235 (5.97)	0.059 (1.5)	0.216 (5.5)	0.070 (1.78)	0.157 (4.0)	0.472 (12.0)
F	12 mm	0.231 (5.88)	0.059 (1.5)	0.216 (5.5)	0.060 (1.53)	0.157 (4.0)	0.472 (12.0)
N	12 mm	0.150 (3.8)	0.059 (1.5)	0.216 (5.5)	0.047 (1.2)	0.157 (4.0)	0.472 (12.0)
Т	12 mm	0.150 (3.8)	0.059 (1.5)	0.216 (5.5)	0.063 (1.60)	0.157 (4.0)	0.472 (12.0)

Document Number: 40133 Revision: 22-Jun-10



Solid Tantalum Chip Capacitors MICROTANTM High Reliability, Low DCL, Leadframeless Molded



STANDARD PACKAGING QUANTITY					
SERIES	CASE CODE	QTY (PCS/REEL)			
SENIES	CASE CODE	7" REEL	1/2 REEL	SMALL REEL	
	K	5000	2500	300	
	M	4000	2000	300	
	Р	3000	1500	300	
	Q	4000	2000	300	
	D	2500	1250	300	
тм8	E	2500	1250	300	
TWO	F	2500	1250	300	
	L	2500	1250	300	
	N	2500	1250	300	
	R	2500	1250	300	
	Т	2500	1250	300	
	W	2500	1250	300	

POWER DISSIPATION						
SERIES	CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT + 25 °C (W) IN FREE AIR				
	K	0.015				
	M	0.025				
	P	0.045				
	Q	0.045				
	D	0.084				
TM8	E	0.090				
TWO	F	0.110				
	L	0.035				
	N	0.075				
	R	0.045				
	Т	0.084				
	W	0.040				

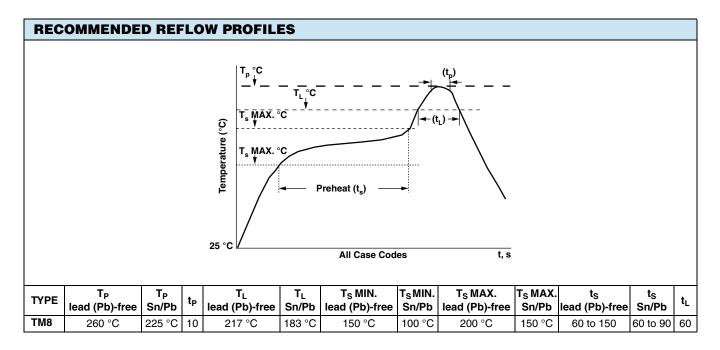
www.vishay.com

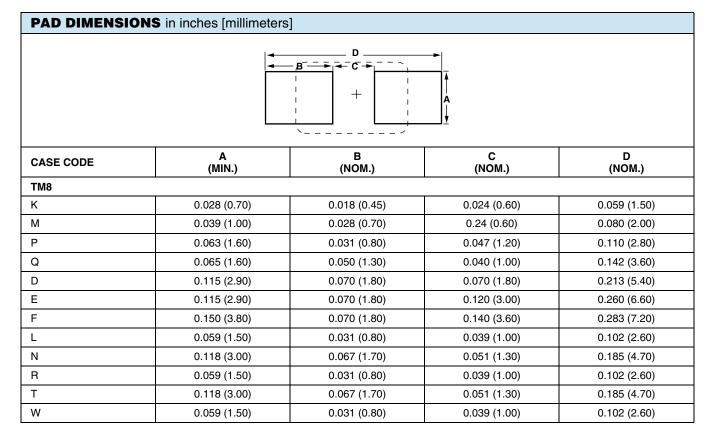
For technical questions, contact: tantalum@vishay.com

Document Number: 40133 Revision: 22-Jun-10



Vishay Sprague





Solid Tantalum Chip Capacitors MICROTANTM High Reliability, Low DCL, Leadframeless Molded



GUIDE TO APPLICATION

 A-C Ripple Current: The maximum allowable ripple current shall be determined from the formula:

$$I_{rms} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = Power dissipation in watts at + 25 °C as

given in the table in paragraph number 5

(power dissipation).

R_{ESR} = The capacitor equivalent series resistance

at the specified frequency.

2. **A-C Ripple Voltage:** The maximum allowable ripple voltage shall be determined from the formula:

$$V_{rms} = Z \sqrt{\frac{P}{R_{ESR}}}$$

or, from the formula:

$$V_{rms} = I_{rms} \times Z$$

where,

P = Power dissipation in watts at + 25 °C as

given in the table in paragraph number 5

(power dissipation).

R_{ESR} = The capacitor equivalent series resistance

at the specified frequency.

Z = The capacitor impedance at the specified

frequency.

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at + 25 °C.
- Reverse Voltage: These capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at + 25 °C, 5 % of the DC rating at + 85 °C and 1 % of the DC rating at + 125 °C.
- 4. **Temperature Derating:** If these capacitors are to be operated at temperatures above + 25 °C, the permissible rms ripple current or voltage shall be calculated using the derating factors as shown:

TEMPERATURE	DERATING FACTOR
+ 25 °C	1.0
+ 85 °C	0.9
+ 125 °C	0.4

5. Power Dissipation: Power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{rms} value be established when calculating permissible operating levels. (Power Dissipation calculated using + 25 °C temperature rise.)

- 6. **Printed Circuit Board Materials:** Molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelanized steel).
- 7. Attachment:
- 7.1 **Solder Paste:** The recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.
- 7.2 **Soldering:** Capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time/temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per second. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor.
- 7.2.1 Backward and Forward Compatibility: Capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
- 8. Cleaning (Flux Removal) After Soldering: Molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC/ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/I at 40 kHz for 2 minutes.
- 9. Recommended Mounting Pad Geometries: Proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and/or circuit board design.

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 www.vishay.com
Revision: 11-Mar-11 1